

FORM PTO-1449 (Modified)

LIST OF PATENTS AND PUBLICATIONS FOR
APPLICANT'S INFORMATION
DISCLOSURE STATEMENT

ATTY. DÖCKE

FIS9-2000-0412-US1

SERIAL-NO.

09/870,531

Division
9-4-01

APPLICANT: Brofman et al.

(Use several sheets if necessary)

FILING DATE: 05/31/01

GROUP: 2815 2813

REFERENCE DESIGNATION

U.S. PATENT DOCUMENTS

EXAMINER INITIALS		DOCUMENT NUMBER	ISSUED DATE	NAME	CLASS	SUBCLASS	FILING DATE (IF APPRO.)
JMM	AA	5,258,236	11/02/93	Arjavalasingam et al.	428	626	
	AB	5,497,545	03/12/96	Watanabe et al.	29	830	
	AC	5,654,590	08/05/97	Kuramochi	257	778	
	AD	5,965,933	10/12/99	Young et al.	257	621	
	AE	6,036,809	03/14/00	Kelly et al.	156	247	
	AF	6,066,562	05/23/00	Oshima et al.	438	691	
	AG	6,184,060	02/06/01	Siniaguine	438	106	
JMM	AH	6,187,418	02/13/01	Fasano et al.	428	210	

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
							YES	NO
	AI							

OTHER ART (Including Author, Title, Date, Pertinent Pages, etc.)

AK Matsuo et al. "Silicon Interposer Technology for High-density Package", Session 36, Afternoon, Wednesday, May 24, 2000, at Caesar's Palace, Las Vegas, NV, Proceedings of IEEE Electronic Components and Technology Conference, IEEE, ISBN 0780359089, 4 pages, 2000

EXAMINER

DATE CONSIDERED

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.